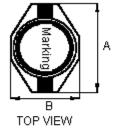
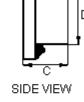
	PART NO.		REVISIONS											
	I	ECN #	REV	DESCRIPTION	DRAWN	DATE	CHECKD	DATE	APPRVD	DATE				
		-	А	RELEASED	Shashi	19/2/11	Jagan	19/2/11	Farnell	05/3/11				

Configurations and Dimensions





 Suggest PCB Layout

Dimensions : Millimetres

Marking: 471

Electrical Characteristics

(at 25°C)

Test Condition		
100KHz 0.1V	L	470μH ±10%
at 25°C	DCR	3.84 Ω (Maximum)
100KHz 0.1V I _{rms} = 0.42A	L at I _{rms}	∆T40°C (Maximum)
Operating temperature : EE	°C to 1120°C	

Operating temperature : -55°C to +130°C

Note : I_{rms} : Temperature Rise 40°C

А	12.95 mm	(Maximum)
В	9.5 mm	(Maximum)
С	5.2 mm	(Maximum)
D	8.4 ±0.3 mm	-
E	7.62 mm	(Reference)
F	2.54 mm	(Reference)
G	2.54 mm	(Reference)

Schematic Diagram





Note:

1. Wire Ø0.11mm x 1P 2UEWF 155°C 2. 138.5TS (Reference)

Test Data for Mechanical

Test Item	A mm	B mm	C mm	D mm	E mm	F mm	G mm
Specification	12.95 (Maximum)	9.5 (Maximum)	5.2 (Maximum)	8.4 ±0.3	7.62 (Reference)	2.54 (Reference)	2.54 (Reference)
1	12.78	9.2	4.81	8.5	7.62	2.52	2.53
2	12.75	9.22	4.8	8.48	7.6	2.51	2.52
3	12.78	9.23	4.81	8.51	7.61	2.53	2.53
4	12.8	9.18	4.78	8.52	7.62	2.5	2.51
5	12.76	9.20	4.79	8.49	7.59	2.52	2.52
Average	12.77	9.21	4.8	8.5	7.61	2.52	2.52

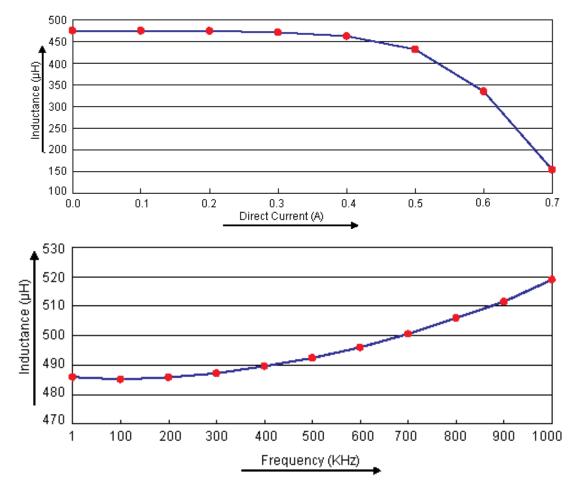
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data sheet should check for themselves the Information and the suitability of the prod- ucts for their purpose and not make any assumptions based on information included or	DIMENSIONS ARE FOR REFERENCE	Jagan	19/02/11	Δ	M10003449	BFS5220-471KU	A
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multicomp	PART NO.		REVISIONS										
	MCBFS5220-471KU	ECN #	REV	DESCRIPTION	DRAWN	DATE	CHECKD	DATE	APPRVD	DATE			
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Test Data for Electrical

Test Item	L µH	DCR Ω	L at I _{rms} μΗ
Condition	100KHz 0.1V	at 25°C	100KHz 0.1V I _{rms} = 0.42A
Specification	470 ±10%	3.84 (Maximum)	∆T40°C (Maximum)
1	467.8	3.17	ОК
2	483.3	3.09	ОК
3	472.5	3.13	ОК
4	480.1	3.09	ОК
5	475.4	3.1	ОК
Average	475.82	3.11	ОК

Electric Characteristics



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	MCBFS5220-471KU	ECN #	REV	DESCRIPTION	DRAWN	DATE	CHECKD	DATE	APPRVD	DATE		
		-	А	RELEASED	Shashi	19/2/11	Jagan	19/2/11	Farnell	05/3/11		

Reliability Test

Test Item	Specifications	Test Method and Remarks
Solder ability	The electrodes shall be at least 90% covered with new solder coating.	According to IEC68-2-20; 1. Soldering temperature : 245 ±5°C 2. Solder : 99.3Sn/0.7Cu 3. Flux : Rosin 4. Immersion time : 5 ±1 seconds
Soldering heat resistance	1. Appearance : no damage 2. Inductance change : within ±10% of initial value	 Preheat temperature: 150°C Preheat time : 1 min Solder temperature : 260 ±5°C Dipping time : 10 ±1 seconds Measured at room temperature after placing for 24 hours.
Vibration (Out Lab)	 Appearance : no damage All electrical and mechanical parameters within tolerance. 	 According to MIL-STD202 Method204; 1. Frequency : 10 to 55Hz 2. Amplitude : 1.52mm 3. Direction and time X Y and Z Direction for 2 hours each.
Humidity resistance test	 Appearance : no damage All electrical and mechanical parameters within tolerance. 	 According to IEC68-2-2 MethodCa; 1. Temperature : 40 ±2°C 2. Humidity : 90 to 95% RH 3. Test time : 500 ±2H 4. The component should be stabilized at normal condition for 24 hours before test.
High temperature resistance test	1. Appearance : no damage 2. All electrical and mechanical parameters within tolerance.	According to IEC68-2-2; 1. Temperature : 85 ±3°C 2. Test time : 500 +24H 3. The component should be stabilized at normal condition for 24 hours before test.

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		ECN #	REV	DESCRIPTION	DRAWN	DATE	CHECKD	DATE	APPRVD	DATE			
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Reliability Test

Test Item	Specifications	Test Method and Remarks		
Low temperature resistance test	1. Appearance : no damageAccording to IEC68-2-1 Method A(Ad);2. All electrical and mechanical parameters within tolerance1. Temperature : 40 ±3°C2. Test time : 500 +24H2. Test time : 500 +24H3. The component should be stabilized at normal conhours before test.			
Temperature cycles test	1. Appearance : no damage 2. All electrical and mechanical parameters within tolerance	 According to IEC68-2-14 Method N(Nb); 1. High temperature : 85 ±3 duration : 30 minutes 2. Room temperature : 25 ±2°C duration 3H 3. Low temperature : -40 ±3 duration 30 minutes 4. Room temperature : 25 ±2°C duration 3H 5. Number of cycle : 10 cycles 6. The component should be stabilized at normal condition for 24 hours before test. 		

Material List

No.	ltem	Material Description		
1	Core	R5A DR 4.8 x 4 R5A RI 8.4 x 4.1 x 6.85		
2	Wire	Ø0.11mm x 1P 2UEWF 155°C		
3	Solder (Lead Free)	99.3%Sn/0.7%Cu		
4	Glue	TH320D/TH320-3		
5	Base	SN-BS019.01 LCP		

Part Number Table

Description	Part Number
•	
Inductor, 470µH, 10%, SMD	MCBFS5220-471KU

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		Jagan	19/02/11	Δ			
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